

Vishay Semiconductors

IR Receiver Modules for Remote Control Systems



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DESCRIPTION

This IR receiver series is optimized for long burst remote control systems in different environments. The customer can chose between different IC settings (AGC variants), to find the optimum solution for his application. The higher the AGC, the better noise is suppressed, but the lower the code compatibility.

The devices contain a PIN diode and a preamplifier assembled on a lead frame. The epoxy package contains an IR filter. The demodulated output signal can be directly connected to a microprocessor for decoding. These components have not been qualified to automotive specifications.

FEATURES

Individual IC settings to reach maximum performance



- Immunity against noise (lamps, LCD TV, Wi-Fi)
- Low supply current
- · Photo detector and preamplifier in one package
- Supply voltage: 2.0 V to 5.5 V
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



LINKS TO ADDITIONAL RESOURCES





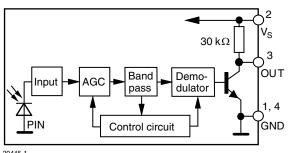
APPLICATIONS

· Infrared remote control systems

DESIGN SUPPORT TOOLS

- 3D models
- Window size calculator

BLOCK DIAGRAM



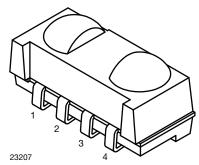


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MECHANICAL DATA

Pinning:

1, 4 = GND, $2 = V_S$, 3 = OUT

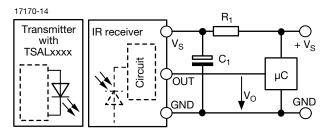


ORDERING CODE

Taping:

TSOP77...TT - top view taped, 2200 pcs/reel TSOP77...TR - side view taped, 2300 pcs/reel

APPLICATION CIRCUIT



 R_1 and C_1 recommended in case there are strong ripple or spikes on the supply line.

PARTS T	ABLE			
AGC		LEGACY, FOR LONG BURST REMOTE CONTROLS (AGC2)	RECOMMENDED FOR LONG BURST CODES (AGC4)	
	30 kHz	TSOP77230	TSOP77430	
Carrier frequency	33 kHz	TSOP77233	TSOP77433	
	36 kHz	TSOP77236	TSOP77436 (1)(2)(3)	
	38 kHz	TSOP77238	TSOP77438 (4)(5)(9)(10)	
	40 kHz	TSOP77240 ⁽⁸⁾	TSOP77440	
	56 kHz	TSOP77256 (11)	TSOP77456 (6)(7)	
Package		Heimo	dall	
Pinning		1, 4 = GND, 2 =	V _S , 3 = OUT	
Dimensions	(mm)	6.8 W x 3.0 I	H x 3.2 D	
Mounting		SME)	
Application		Remote control		
Best choice	for	(1) RC-5 (2) RC-6 (3) Panasonic (4) NEC (8) Sony (9) Mitsubishi (10)	⁽⁵⁾ Sharp ⁽⁶⁾ r-step ⁽⁷⁾ Thomson RCA Sejin 4PPM ⁽¹¹⁾ Cisco	
Special option	ons	Extended temperature range: www.vishay.com/doc?81590 Narrow optical filter: www.vishay.com/doc?82726 Wide optical filter: www.vishay.com/doc?82726	82738	

ABSOLUTE MAXIMUM RA	MAXIMUM RATINGS			
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Supply voltage		V _S	-0.3 to +6	V
Supply current		I _S	5	mA
Output voltage		Vo	-0.3 to (V _S + 0.3)	V
Output current		Io	5	mA
Junction temperature		Tj	100	°C
Storage temperature range		T _{stg}	-25 to +85	°C
Operating temperature range		T _{amb}	-25 to +85	°C
Power consumption	T _{amb} ≤ 85 °C	P _{tot}	10	mW

Note

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only
and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification
is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability



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ELECTRICAL AND	OPTICAL CHARACTERISTICS (T _{amb} = 25	°C, unles	s otherwi	se specif	ied)	
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply voltage		Vs	2.0	-	5.5	V
Supply current	$V_S = 3.3 \text{ V}, E_V = 0$	I _{SD}	0.25	0.35	0.45	mA
Supply current	$E_v = 40$ klx, sunlight I_{SH}	I _{SH}	-	0.45	-	mA
Transmission distance	$E_V = 0$, IR diode TSAL6200, $I_F = 50$ mA, test signal see Fig. 1	d	-	18	-	m
Output voltage low	$I_{OSL} = 0.5 \text{ mA}, E_e = 0.7 \text{ mW/m}^2$, test signal see Fig. 1	V _{OSL}	-	-	100	mV
Minimum irradiance	Test signal: RC5	E _{e min.}	-	0.2	0.4	mW/m ²
Willimum madiance	Test signal: NEC code	E _{e min.}	-	0.3	0.5	mW/m ²
Maximum irradiance	t_{pi} - $4/f_o < t_{po} < t_{pi} + 4/f_o$	E _{e max.}	30	-	-	W/m ²
Directivity	Angle of half transmission distance	Ψ1/2	-	± 50	-	0

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

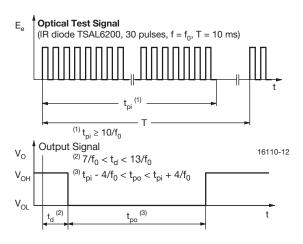


Fig. 1 - Output Active Low

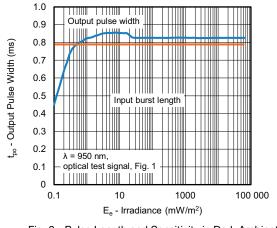
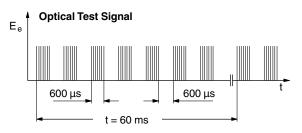
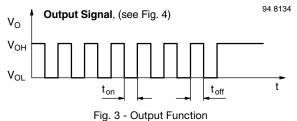


Fig. 2 - Pulse Length and Sensitivity in Dark Ambient





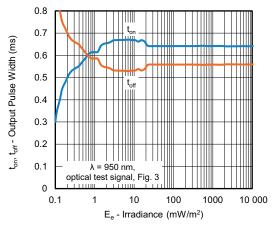


Fig. 4 - Output Pulse Diagram



щ

16925

0.0

0.7

TSOP772.., TSOP774..

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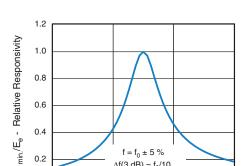


Fig. 5 - Frequency Dependence of Responsivity

0.9

 $\Delta f(3 \text{ dB}) = f_0/10$

f/f₀ - Relative Frequency

1.1

1.3

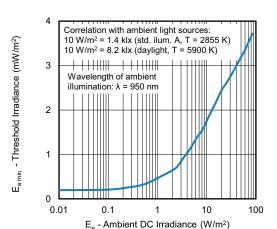


Fig. 6 - Sensitivity in Bright Ambient

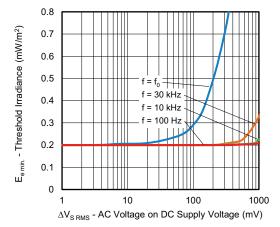


Fig. 7 - Sensitivity vs. Supply Voltage Disturbances

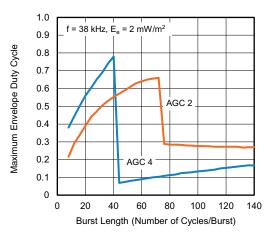


Fig. 8 - Max. Envelope Duty Cycle vs. Burst Length

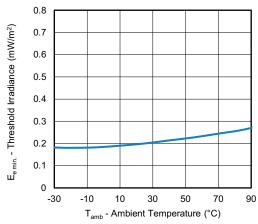


Fig. 9 - Sensitivity vs. Ambient Temperature

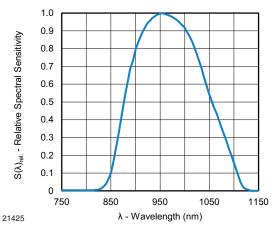


Fig. 10 - Relative Spectral Sensitivity vs. Wavelength



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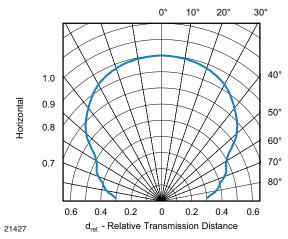


Fig. 11 - Horizontal Directivity

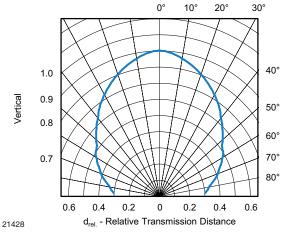


Fig. 12 - Vertical Directivity

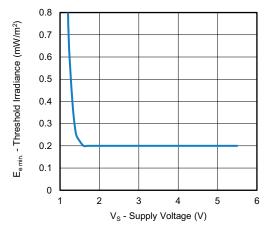


Fig. 13 - Sensitivity vs. Supply Voltage



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SUITABLE DATA FORMAT

This series is designed to suppress spurious output pulses due to noise or disturbance signals. The devices can distinguish data signals from noise due to differences in frequency, burst length, and envelope duty cycle. The data signal should be close to the device's band-pass center frequency (e.g. 38 kHz) and fulfill the conditions in the table below.

When a data signal is applied to the product in the presence of a disturbance, the sensitivity of the receiver is automatically reduced by the AGC to insure that no spurious pulses are present at the receiver's output.

Some examples which are suppressed are:

- DC light (e.g. from tungsten bulbs sunlight)
- · Continuous signals at any frequency
- Strongly or weakly modulated noise from fluorescent lamps with electronic ballasts (see Fig. 14 or Fig. 15)
- 2.4 GHz and 5 GHz Wi-Fi

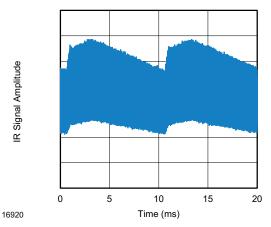


Fig. 14 - IR Disturbance from Fluorescent Lamp With Low Modulation

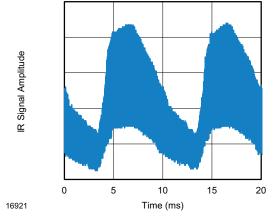


Fig. 15 - IR Disturbance from Fluorescent Lamp With High Modulation

	TSOP772	TSOP774
Minimum burst length	10 cycles/burst	10 cycles/burst
After each burst of length a minimum gap time is required of	10 to 72 cycles ≥ 10 cycles	10 to 40 cycles ≥ 10 cycles
For bursts greater than a minimum gap time in the data stream is needed of	72 cycles > 3 x burst length	40 cycles > 10 x burst length
Maximum number of continuous short bursts/second	950	1500
NEC code	Yes	Preferred
RC5 / RC6 code	Yes	Preferred
Thomson RCA 56 kHz code	Yes	Preferred
Sharp code	Yes	Preferred
Sony code	Preferred	No
r-step code	Yes	Preferred
Suppression of interference from fluorescent lamps	Mild disturbance patterns are suppressed (example: signal pattern of Fig. 14)	Complex and critical disturbance patterns are suppressed (example: signal pattern of Fig. 15 or highly dimmed LCDs)

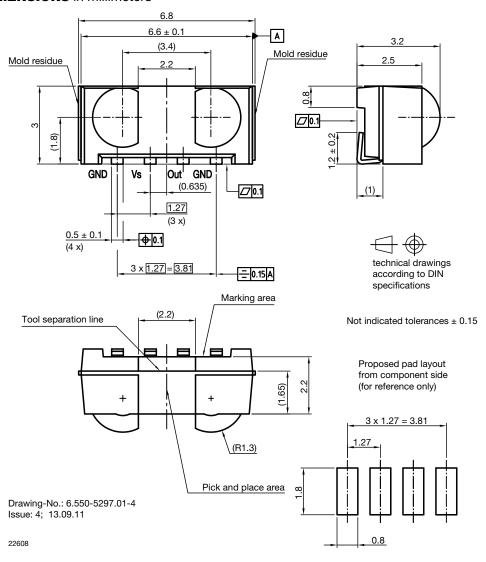
Note

For data formats with short bursts please see the datasheet of TSOP773.. and TSOP775..



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PACKAGE DIMENSIONS in millimeters



ASSEMBLY INSTRUCTIONS

Reflow Soldering

- Reflow soldering must be done within 72 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope
- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Exercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured
- Handling after reflow should be done only after the work surface has been cooled off

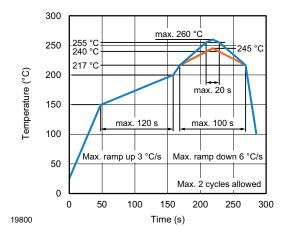
Manual Soldering

- Use a soldering iron of 25 W or less. Adjust the temperature of the soldering iron below 300 °C
- Finish soldering within 3 s
- · Handle products only after the temperature has cooled off



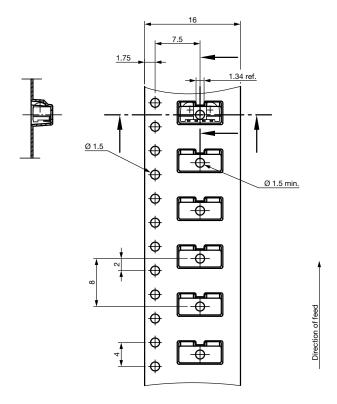
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VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE



TAPING VERSION TSOP..TR DIMENSIONS in millimeters





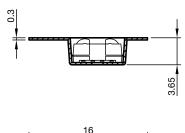
Drawing-No.: 9.700-5337.01-4 Issue: 2; 06.10.15 technical drawings according to DIN specifications

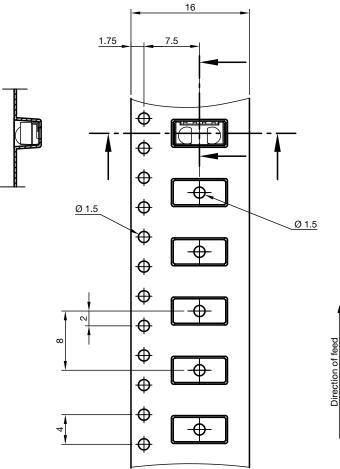
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TAPING VERSION TSOP..TT DIMENSIONS in millimeters





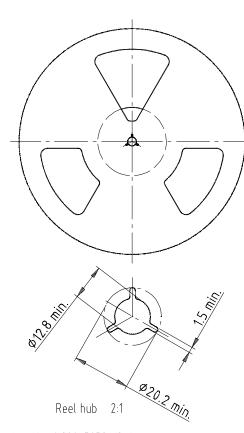


Drawing-No.: 9.700-5338.01-4 Issue: 4; 12.06.13



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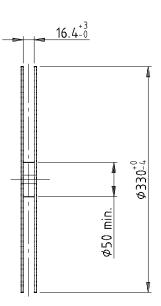
REEL DIMENSIONS in millimeters



Drawing-No.: 9.800-5052.V2-4

Issue: 1; 07.05.02

16734



Form of the leave open of the wheel is supplier specific.

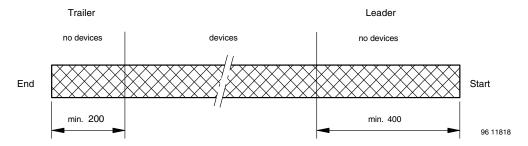
Dimension acc. to IEC EN 60 286-3

Tape width 16



technical drawings according to DIN specifications

LEADER AND TRAILER DIMENSIONS in millimeters



COVER TAPE PEEL STRENGTH

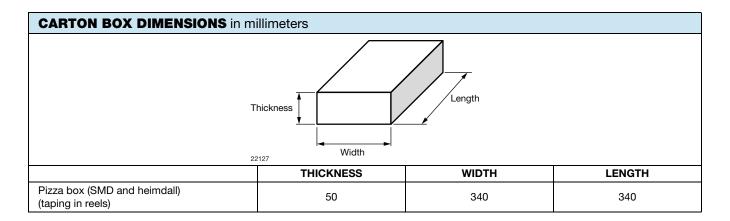
According to DIN EN 60286-3 0.1 N to 1.3 N 300 ± 10 mm/min. 165° to 180° peel angle



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OUTER PACKAGING

The sealed reel is packed into a pizza box.



LABEL

Standard bar code labels for finished goods

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

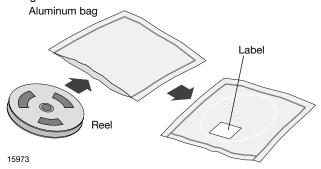
PLAIN WRITING	ABBREVIATION	LENGTH
Item-description	-	18
Item-number	INO	8
Selection-code	SEL	3
LOT-/serial-number	BATCH	10
Data-code	COD	3 (YWW)
Plant-code	PTC	2
Quantity	QTY	8
Accepted by	ACC	-
Packed by	PCK	-
Mixed code indicator	MIXED CODE	-
Origin	xxxxxx+	Company logo
LONG BAR CODE TOP	TYPE	LENGTH
Item-number	N	8
Plant-code	N	2
Sequence-number	X	3
Quantity	N	8
Total length	-	21
SHORT BAR CODE BOTTOM	TYPE	LENGTH
Selection-code	X	3
Data-code	N	3
Batch-number	X	10
Filter	-	1
Total length	-	17



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DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

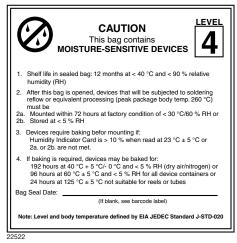
After more than 72 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition: 192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or

96 h at 60 °C + 5 °C and < 5 % RH for all device containers or

24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC® standard J-STD-020 level 4 label is included on all dry bags.



EIA JEDEC standard J-STD-020 level 4 label is included on all dry bags

ESD PRECAUTION

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS (example)

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



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